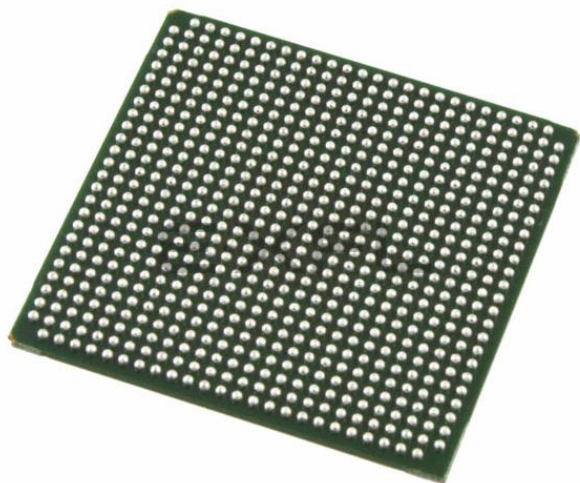




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	402
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20e-7f672c

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

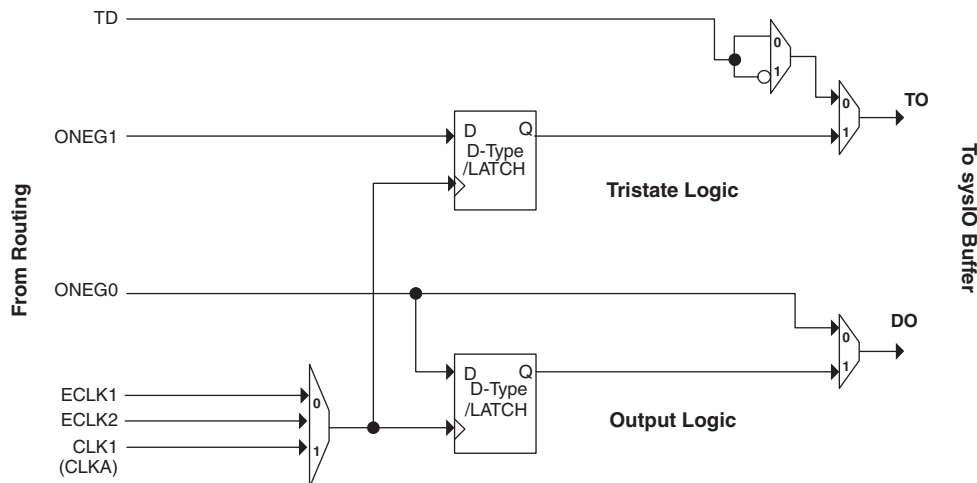
Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

Figure 2-32. Output and Tristate Block, Top Edge



Note: Simplified version does not show CE and SET/RESET details.

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sysIO buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block with the Output Block for the left, right and bottom edges and Figure 2-32 shows the diagram of the Tristate Register Block with the Output Block for the top edge.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 and OPOS1 are fed into registers on the positive edge of the clock. Then in the next clock the registered OPOS1 is latched. A multiplexer running off the same clock cycle selects the correct register for feeding to the output (DO).

Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing, one of the edge clocks (ECLK1/ ECLK2) and a DQS signal provided from the programmable DQS pin and provided to the input register block. The clock can optionally be inverted.

DDR Memory Support

Certain PICs have additional circuitry to allow the implementation of high speed source synchronous and DDR memory interfaces. The support varies by the edge of the device as detailed below.

Left and Right Edges

PICs on these edges have registered elements that support DDR memory interfaces. One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 16 PIOs. Figure 2-33 shows the assignment of DQS pins in each set of 16 PIOs.

Bottom Edge

PICs on the bottom edge have registered elements that support DDR memory interfaces. One of every 18 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 18 PIOs. Figure 2-34 shows the assignment of DQS pins in each set of 18 PIOs.

Table 2-14. Supported Output Standards

Output Standard	Drive	V _{CCIO} (Nom.)
Single-ended Interfaces		
LVTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVC MOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVC MOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVC MOS18	4mA, 8mA, 12mA, 16mA	1.8
LVC MOS15	4mA, 8mA	1.5
LVC MOS12	2mA, 6mA	1.2
LVC MOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVC MOS15, Open Drain	4mA, 8mA	—
LVC MOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II	N/A	1.8
HSTL15 Class I	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I, II	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I, II	N/A	1.8
Differential HSTL18, Class I, II	N/A	1.8
Differential HSTL15, Class I	N/A	1.5
LVDS	N/A	2.5
MLVDS ¹	N/A	2.5
BLVDS ¹	N/A	2.5
LVPECL ¹	N/A	3.3
RSDS ¹	N/A	2.5
LVC MOS33D ¹	4mA, 8mA, 12mA, 16mA, 20mA	3.3

1. Emulated with external resistors. For more detail, please see information regarding additional technical documentation at the end of this data sheet.

Hot Socketing

LatticeECP2/M devices have been carefully designed to ensure predictable behavior during power-up and power-down. During power-up and power-down sequences, the I/Os remain in tri-state until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits. This allows for easy integration with the rest of the system. These capabilities make the LatticeECP2/M ideal for many multiple power supply and hot-swap applications.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter	Description	Test Conditions	Min.	Typ.	Max.	Units
$V_{INP} V_{INM}$	Input Voltage		0	—	2.4	V
V_{CM}	Input Common Mode Voltage	Half the Sum of the Two Inputs	0.05	—	2.35	V
V_{THD}	Differential Input Threshold	Difference Between the Two Inputs	+/-100	—	—	mV
I_{IN}	Input Current	Power On or Power Off	—	—	+/-10	μ A
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	—	1.38	1.60	V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	0.9V	1.03	—	V
V_{OD}	Output Voltage Differential	$(V_{OP} - V_{OM})$, $R_T = 100 \text{ Ohm}$	250	350	450	mV
ΔV_{OD}	Change in V_{OD} Between High and Low		—	—	50	mV
V_{OS}	Output Voltage Offset	$(V_{OP} + V_{OM})/2$, $R_T = 100 \text{ Ohm}$	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} Between H and L		—	—	50	mV
I_{SA}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Ground	—	—	24	mA
I_{SAB}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Each Other	—	—	12	mA

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	NC	5			PB16B	5	BDQ15	C
47	GND	-			GND	-		
48	VCC				VCC	-		
49	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
50	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
51	GND	-			GND	-		
52	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
53	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
54	VCC	-			VCC	-		
55	PB14A	4	BDQ15	T	PB34A	4	BDQ33	T
56	PB14B	4	BDQ15	C	PB34B	4	BDQ33	C
57	PB16A	4	BDQ15	T	PB40A	4	BDQ42	T
58	PB16B	4	BDQ15	C	PB40B	4	BDQ42	C
59	PB18A	4	BDQ15	T	PB44A	4	BDQ42	T
60	PB18B	4	BDQ15	C	PB44B	4	BDQ42	C
61	GND	-			GND	-		
62	PB20A	4	BDQ24	T	PB48A	4	BDQ51	T
63	PB20B	4	BDQ24	C	PB48B	4	BDQ51	C
64	VCCIO4	4			VCCIO4	4		
65	PB22A	4	BDQ24	T	PB50A	4	BDQ51	T
66	PB22B	4	BDQ24	C	PB50B	4	BDQ51	C
67	PB24A	4	BDQS24	T	PB52A	4	BDQ51	T
68	PB24B	4	BDQ24	C	PB52B	4	BDQ51	C
69	PB26A	4	BDQ24	T	PB54A	4	BDQ51	T
70	PB26B	4	BDQ24	C	PB54B	4	BDQ51	C
71	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
72	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
73	CFG1	8			CFG1	8		
74	CFG2	8			CFG2	8		
75	PROGRAMN	8			PROGRAMN	8		
76	INITN	8			INITN	8		
77	CFG0	8			CFG0	8		
78	CCLK	8			CCLK	8		
79	DONE	8			DONE	8		
80	PR29A	8	D0/SPIFASTN		PR29A	8	D0/SPIFASTN	
81	GND	-			GND	-		
82	PR26A	8	D6		PR26A	8	D6	
83	VCC	-			VCC	-		
84	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
85	VCCIO8	8			VCCIO8	8		
86	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
87	PR24B	8	DOUT/CSON	C	PR24B	8	DOUT/CSON	C
88	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
89	VCCIO3	3			VCCIO3	3		
90	VCCAUX	-			VCCAUX	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
V23	PR70A	3	RDQ71	T
W27	PR69B	3	RDQ71	C (LVDS)*
W28	PR69A	3	RDQ71	T (LVDS)*
V26	PR68B	3	RDQ71	C
VCCIO	VCCIO3	3		
V24	PR68A	3	RDQ71	T
W29	PR67B	3	RDQ71	C (LVDS)*
W30	PR67A	3	RDQ71	T (LVDS)*
U25	PR66B	3	RDQ63	C
GND	GNDIO3	-		
U23	PR66A	3	RDQ63	T
V29	PR65B	3	RDQ63	C (LVDS)*
V30	PR65A	3	RDQ63	T (LVDS)*
U26	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
U24	PR64A	3	RDQ63	T
U27	PR63B	3	RDQ63	C (LVDS)*
U28	PR63A	3	RDQS63	T (LVDS)*
GND	GNDIO3	-		
T23	PR62B	3	RDQ63	C
T25	PR62A	3	RDQ63	T
U29	PR61B	3	RDQ63	C (LVDS)*
U30	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
T24	PR60B	3	VREF2_3/RDQ63	C
T26	PR60A	3	VREF1_3/RDQ63	T
T27	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
T28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
R24	PR57B	2	PCLKC2_0/RDQ54	C
R26	PR57A	2	PCLKT2_0/RDQ54	T
GND	GNDIO2	-		
T29	PR56B	2	RDQ54	C (LVDS)*
T30	PR56A	2	RDQ54	T (LVDS)*
R23	PR55B	2	RDQ54	C
R25	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
R27	PR54B	2	RDQ54	C (LVDS)*
R28	PR54A	2	RDQS54	T (LVDS)*
P26	PR53B	2	RDQ54	C
GND	GNDIO2	-		
P24	PR53A	2	RDQ54	T
R29	PR52B	2	RDQ54	C (LVDS)*
R30	PR52A	2	RDQ54	T (LVDS)*

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO6	-			GNDIO6	-		
L1	PL42A	6	LLM0_GPLLT_IN_A	T (LVDS)*	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57***	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
L2	PL42B	6	LLM0_GPLLC_IN_A	C (LVDS)*	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*
L3	PL43A	6	LLM0_GPLLT_FB_A	T	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T
L4	PL43B	6	LLM0_GPLLC_FB_A	C	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C
VCCIO	VCCIO6	6			VCCIO6	6		
M1	PL44A	6	LLM0_GDLLT_IN_A	T (LVDS)*	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*
N1	PL44B	6	LLM0_GDLLC_IN_A	C (LVDS)*	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*
N2	PL45A	6	LLM0_GDLLT_FB_A	T	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T
N3	PL45B	6	LLM0_GDLLC_FB_A	C	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C
GNDIO	GNDIO6	-			GNDIO6	-		
M4	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
VCCIO	VCCIO6	6			VCCIO6	6		
GNDIO	GNDIO6	-			GNDIO6	-		
K6	TCK	-			TCK	-		
L5	TDI	-			TDI	-		
N4	TMS	-			TMS	-		
N6	TDO	-			TDO	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	BDQ6	T	PB2A	5	BDQ6	T
N5	PB2B	5	BDQ6	C	PB2B	5	BDQ6	C
L6	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
M6	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
P3	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
P4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
P2	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
P1	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
R1	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
GNDIO	GNDIO5	-			GNDIO5	-		
R2	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
R3	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
T2	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
R4	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
T4	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T
GNDIO	GNDIO5	-			GNDIO5	-		
T5	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
T6	PB16A	5	VREF2_5/BDQ15	T	PB34A	5	VREF2_5/BDQ33	T
R6	PB16B	5	VREF1_5/BDQ15	C	PB34B	5	VREF1_5/BDQ33	C
P6	PB17A	5	PCLKT5_0/BDQ15	T	PB35A	5	PCLKT5_0/BDQ33	T
P7	PB17B	5	PCLKC5_0/BDQ15	C	PB35B	5	PCLKC5_0/BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO7	-		
L1	PL36A	7	LDQS36	T (LVDS)*
L2	PL36B	7	LDQ36	C (LVDS)*
M7	PL37A	7	LDQ36	T
VCCIO	VCCIO7	7		
L5	PL37B	7	LDQ36	C
L3	PL38A	7	LDQ36	T (LVDS)*
L4	PL38B	7	LDQ36	C (LVDS)*
M1	PL39A	7	PCLKT7_0/LDQ36	T
GNDIO	GNDIO7	-		
M2	PL39B	7	PCLKC7_0/LDQ36	C
M6	PL41A	6	PCLKT6_0	T (LVDS)*
M5	PL41B	6	PCLKC6_0	C (LVDS)*
M3	PL42A	6	VREF2_6	T
M4	PL42B	6	VREF1_6	C
VCCIO	VCCIO6	6		
N7	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO6	-		
N6	PL45B	6	LLM3_SPLLC_IN_A	C (LVDS)*
N1	PL46A	6	LLM3_SPLLT_FB_A	T
N2	PL46B	6	LLM3_SPLLC_FB_A	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
P6	PL52A	6	LDQS52****	T (LVDS)*
N5	PL52B	6	LDQ52	C (LVDS)*
P1	PL53A	6	LDQ52	T
VCCIO	VCCIO6	6		
P2	PL53B	6	LDQ52	C
P3	PL54A	6	LDQ52	T (LVDS)*
P4	PL54B	6	LDQ52	C (LVDS)*
P5	PL55A	6	LDQ52	T
GNDIO	GNDIO6	-		
P7	PL55B	6	LDQ52	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
R1	PL62A	6	LLM0_GPLLT_IN_A**	T (LVDS)*
GNDIO	GNDIO6	-		
R2	PL62B	6	LLM0_GPLLC_IN_A**	C (LVDS)*
R3	PL63A	6	LLM0_GPLLT_FB_A	T
R4	PL63B	6	LLM0_GPLLC_FB_A	C
VCCIO	VCCIO6	6		
R6	PL64A	6	LLM0_GDLLT_IN_A**	T (LVDS)*
R5	PL64B	6	LLM0_GDLLC_IN_A**	C (LVDS)*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K19	PR16A	2	RDQ15	T	PR19A	2		T	
G24	PR15B	2	RDQ15	C (LVDS)*	PR18B	2		C*	
G23	PR15A	2	RDQS15	T (LVDS)*	PR18A	2		T*	
GNDIO	GNDIO2	-			GNDIO2	-			
J18	PR14B	2	RDQ15	C	PR14B	2		C	
F22	PR14A	2	RDQ15	T	PR14A	2		T	
-	-	-			VCCIO2	2			
F23	PR13B	2	RDQ15	C (LVDS)*	PR13B	2		C*	
F24	PR13A	2	RDQ15	T (LVDS)*	PR13A	2		T*	
VCCIO	VCCIO2	2			-	-			
H20	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C	PR12B	2	RUM0_SPLLC_FB_A	C	
-	-	-			GNDIO2	-			
F21	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T	PR12A	2	RUM0_SPLLT_FB_A	T	
G26	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A	C*	
F26	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A	T*	
-	-	-			VCCIO2	2			
E24	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C	
GNDIO	GNDIO2	-			GNDIO2	-			
E23	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T	
VCCIO	VCCIO4	4			VCCIO2	2			
H19	XRES	-			XRES	-			
C25	URC_SQ_VCCR_X0	12			URC_SQ_VCCR_X0	12			
A24	URC_SQ_HDIN_P0	12		T	URC_SQ_HDIN_P0	12		T	
B25	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12			
B24	URC_SQ_HDIN_N0	12		C	URC_SQ_HDIN_N0	12		C	
C22	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12			
A21	URC_SQ_HDOUT_P0	12		T	URC_SQ_HDOUT_P0	12		T	
A22	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12			
B21	URC_SQ_HDOUT_N0	12		C	URC_SQ_HDOUT_N0	12		C	
C21	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12			
B20	URC_SQ_HDOUT_N1	12		C	URC_SQ_HDOUT_N1	12		C	
C20	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12			
A20	URC_SQ_HDOUT_P1	12		T	URC_SQ_HDOUT_P1	12		T	
C24	URC_SQ_VCCR_X1	12			URC_SQ_VCCR_X1	12			
B23	URC_SQ_HDIN_N1	12		C	URC_SQ_HDIN_N1	12		C	
C23	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12			
A23	URC_SQ_HDIN_P1	12		T	URC_SQ_HDIN_P1	12		T	
B19	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12			
E19	URC_SQ_REFCLK_N	12		C	URC_SQ_REFCLK_N	12		C	
D19	URC_SQ_REFCLK_P	12		T	URC_SQ_REFCLK_P	12		T	
C19	URC_SQ_VCCP	12			URC_SQ_VCCP	12			
A15	URC_SQ_HDIN_P2	12		T	URC_SQ_HDIN_P2	12		T	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C15	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12			
B15	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C	
C14	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12			
A18	URC_SQ_HDOUP2	12		T	URC_SQ_HDOUP2	12		T	
C18	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12			
B18	URC_SQ_HDOUPN2	12		C	URC_SQ_HDOUPN2	12		C	
C17	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12			
B17	URC_SQ_HDOUPN3	12		C	URC_SQ_HDOUPN3	12		C	
A16	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12			
A17	URC_SQ_HDOUPP3	12		T	URC_SQ_HDOUPP3	12		T	
C16	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12			
B14	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C	
B13	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12			
A14	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T	
C13	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12			
-	-	-			GNDIO1	-			
-	-	-			VCCIO1	1			
E17	PT46B	1		C	PT55B	1		C	
D17	PT46A	1		T	PT55A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
F17	PT45B	1		C	PT54B	1		C	
D16	PT45A	1		T	PT54A	1		T	
F19	PT44B	1		C	PT53B	1		C	
F18	PT44A	1		T	PT53A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
E16	PT43B	1		C	PT52B	1		C	
D15	PT43A	1		T	PT52A	1		T	
G18	PT42B	1		C	PT51B	1		C	
E15	PT42A	1		T	PT51A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
G17	PT41B	1		C	PT50B	1		C	
E14	PT41A	1		T	PT50A	1		T	
D14	PT40B	1		C	PT49B	1		C	
D13	PT40A	1		T	PT49A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
F15	PT39B	1	VREF2_1	C	PT48B	1	VREF2_1	C	
E12	PT39A	1	VREF1_1	T	PT48A	1	VREF1_1	T	
H17	PT38B	1	PCLKC1_0	C	PT47B	1	PCLKC1_0	C	
E13	PT38A	1	PCLKT1_0	T	PT47A	1	PCLKT1_0	T	
C12	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
G15	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T	
C11	PT36B	0	VREF2_0	C	PT45B	0	VREF2_0	C	
F14	PT36A	0	VREF1_0	T	PT45A	0	VREF1_0	T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T29	PR48B	3	RDQ52	C (LVDS)*	PR60B	3	RDQ64	C (LVDS)*	
T28	PR48A	3	RDQ52	T (LVDS)*	PR60A	3	RDQ64	T (LVDS)*	
R23	PR46B	3	RLM3_SPLLC_FB_A	C	PR58B	3	RLM3_SPLLC_FB_A/RDQ55	C	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			-	-			
R22	PR46A	3	RLM3_SPLLT_FB_A	T	PR58A	3	RLM3_SPLLT_FB_A/RDQ55	T	
P30	PR45B	3	RLM3_SPLLC_IN_A	C (LVDS)*	PR57B	3	RLM3_SPLLC_IN_A/RDQ55	C (LVDS)*	
R29	PR45A	3	RLM3_SPLLT_IN_A	T (LVDS)*	PR57A	3	RLM3_SPLLT_IN_A/RDQ55	T (LVDS)*	
T27	PR44B	3		C	PR56B	3	RDQ55	C	
-	-	-			VCCIO3	3			
T26	PR44A	3		T	PR56A	3	RDQ55	T	
GNDIO	GNDIO3	-			GNDIO3	-			
N30	PR43B	3		C (LVDS)*	PR53B	3	RDQ55	C (LVDS)*	
N29	PR43A	3		T (LVDS)*	PR53A	3	RDQ55	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
R27	PR42B	3	VREF2_3	C	PR52B	3	VREF2_3/RDQ55	C	
R28	PR42A	3	VREF1_3	T	PR52A	3	VREF1_3/RDQ55	T	
P29	PR41B	3	PCLKC3_0	C (LVDS)*	PR51B	3	PCLKC3_0/RDQ55	C (LVDS)*	
P28	PR41A	3	PCLKT3_0	T (LVDS)*	PR51A	3	PCLKT3_0/RDQ55	T (LVDS)*	
M30	PR39B	2	PCLKC2_0/RDQ36	C	PR49B	2	PCLKC2_0/RDQ46	C	
M29	PR39A	2	PCLKT2_0/RDQ36	T	PR49A	2	PCLKT2_0/RDQ46	T	
GNDIO	GNDIO2	-			GNDIO2	-			
P23	PR38B	2	RDQ36	C (LVDS)*	PR48B	2	RDQ46	C (LVDS)*	
P24	PR38A	2	RDQ36	T (LVDS)*	PR48A	2	RDQ46	T (LVDS)*	
R26	PR37B	2	RDQ36	C	PR47B	2	RDQ46	C	
P27	PR37A	2	RDQ36	T	PR47A	2	RDQ46	T	
VCCIO	VCCIO2	2			VCCIO2	2			
P25	PR36B	2	RDQ36	C (LVDS)*	PR46B	2	RDQ46	C (LVDS)*	
P26	PR36A	2	RDQS36	T (LVDS)*	PR46A	2	RDQS46	T (LVDS)*	
K30	PR35B	2	RDQ36	C	PR45B	2	RDQ46	C	
GNDIO	GNDIO2	-			GNDIO2	-			
K29	PR35A	2	RDQ36	T	PR45A	2	RDQ46	T	
N22	PR34B	2	RDQ36	C (LVDS)*	PR44B	2	RDQ46	C (LVDS)*	
P22	PR34A	2	RDQ36	T (LVDS)*	PR44A	2	RDQ46	T (LVDS)*	
J30	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C	PR43B	2	RUM3_SPLLC_FB_A/RDQ46	C	
VCCIO	VCCIO2	2			VCCIO2	2			
J29	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T	PR43A	2	RUM3_SPLLT_FB_A/RDQ46	T	
N24	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C (LVDS)*	PR42B	2	RUM3_SPLLC_IN_A/RDQ46	C (LVDS)*	
N23	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T (LVDS)*	PR42A	2	RUM3_SPLLT_IN_A/RDQ46	T (LVDS)*	
N25	PR30B	2	RDQ27	C	PR40B	2	RDQ37	C	
N26	PR30A	2	RDQ27	T	PR40A	2	RDQ37	T	
GNDIO	GNDIO2	-			GNDIO2	-			
M27	PR29B	2	RDQ27	C (LVDS)*	PR39B	2	RDQ37	C (LVDS)*	
M28	PR29A	2	RDQ27	T (LVDS)*	PR39A	2	RDQ37	T (LVDS)*	
H30	PR28B	2	RDQ27	C	PR38B	2	RDQ37	C	
G30	PR28A	2	RDQ27	T	PR38A	2	RDQ37	T	
VCCIO	VCCIO2	2			VCCIO2	2			
M25	PR27B	2	RDQ27	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P16	GND	-			GND	-			
P17	GND	-			GND	-			
P18	GND	-			GND	-			
P20	GND	-			GND	-			
R10	GND	-			GND	-			
R11	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
R15	GND	-			GND	-			
R16	GND	-			GND	-			
R17	GND	-			GND	-			
R18	GND	-			GND	-			
R20	GND	-			GND	-			
R21	GND	-			GND	-			
R24	GND	-			GND	-			
R7	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T13	GND	-			GND	-			
T14	GND	-			GND	-			
T15	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T18	GND	-			GND	-			
T20	GND	-			GND	-			
T21	GND	-			GND	-			
T24	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U15	GND	-			GND	-			
U16	GND	-			GND	-			
U17	GND	-			GND	-			
U18	GND	-			GND	-			
U20	GND	-			GND	-			
V14	GND	-			GND	-			
V15	GND	-			GND	-			
V16	GND	-			GND	-			
V17	GND	-			GND	-			
V27	GND	-			GND	-			
V4	GND	-			GND	-			
W23	GND	-			GND	-			
W8	GND	-			GND	-			
Y14	GND	-			GND	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G7	PL8A	7	LDQ6	T (LVDS)*	NC	-			
G8	PL6A	7	LDQS6****	T (LVDS)*	NC	-			
G9	PL5A	7	LDQ6	T	NC	-			
H19	NC	-			NC	-			
H20	NC	-			NC	-			
H21	NC	-			NC	-			
H22	NC	-			NC	-			
H6	PL8B	7	LDQ6	C (LVDS)*	NC	-			
H8	PL5B	7	LDQ6	C	NC	-			
H9	PL2A	7	LDQ6	T (LVDS)*	NC	-			
J10	PL2B	7	LDQ6	C (LVDS)*	NC	-			
J20	NC	-			NC	-			
J21	NC	-			NC	-			
J9	PL4A	7	LDQ6	T (LVDS)*	NC	-			
K9	PL4B	7	LDQ6	C (LVDS)*	NC	-			
R9	NC	-			NC	-			
U22	NC	-			NC	-			
W9	NC	-			NC	-			
N13	VCCPLL	-			VCCPLL	-			
N18	VCCPLL	-			VCCPLL	-			
V13	VCCPLL	-			VCCPLL	-			
V18	VCCPLL	-			VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AE27	GND	-		
AE4	GND	-		
AE9	GND	-		
AF14	GND	-		
AF17	GND	-		
AF25	GND	-		
AF6	GND	-		
AJ10	GND	-		
AJ21	GND	-		
AJ27	GND	-		
AJ4	GND	-		
AK1	GND	-		
AK13	GND	-		
AK18	GND	-		
AK24	GND	-		
AK30	GND	-		
AK7	GND	-		
B10	GND	-		
B21	GND	-		
B27	GND	-		
B4	GND	-		
D25	GND	-		
D6	GND	-		
E14	GND	-		
E17	GND	-		
F22	GND	-		
F27	GND	-		
F4	GND	-		
F9	GND	-		
G12	GND	-		
G19	GND	-		
J24	GND	-		
J7	GND	-		
K14	GND	-		
K15	GND	-		
K16	GND	-		
K17	GND	-		
K27	GND	-		
K4	GND	-		
L14	GND	-		
L15	GND	-		
L16	GND	-		
L17	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AN29	LRC_SQ_VCCR2	13			LRC_SQ_VCCR2	13		
AM28	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AL27	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AM29	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AL29	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AL30	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AK30	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AK29	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AM30	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AL31	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AM31	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AN30	LRC_SQ_VCCR1	13			LRC_SQ_VCCR1	13		
AP30	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T
AL32	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13		
AP31	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C
AN31	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13		
AP32	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C
AM34	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13		
AP33	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T
AN32	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13		
AM32	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C
AN34	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13		
AM33	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T
AN33	LRC_SQ_VCCR0	13			LRC_SQ_VCCR0	13		
AH28	CFG2	8			CFG2	8		
AD24	CFG1	8			CFG1	8		
AJ29	CFG0	8			CFG0	8		
AF25	PROGRAMN	8			PROGRAMN	8		
AJ28	CCLK	8			CCLK	8		
AE25	INITN	8			INITN	8		
AK31	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AE24	WRITEN***	8			WRITEN***	8		
AJ30	CS1N***	8			CS1N***	8		
AD25	CSN***	8			CSN***	8		
AG29	D0/SPIFASTN***	8			D0/SPIFASTN***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG28	D1***	8			D1***	8		
AG30	D2***	8			D2***	8		
AH29	D3***	8			D3***	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AF26	D4***	8			D4***	8		
AH30	D5***	8			D5***	8		
AE26	D6***	8			D6***	8		
AJ31	D7/SPID0***	8			D7/SPID0***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG27	DI/CSSPI0N***	8			DI/CSSPI0N***	8		
AK32	DOUT/CSN/CSPI1N***	8			DOUT/CSN/CSPI1N***	8		
AK33	BUSY/SISPI***	8			BUSY/SISPI***	8		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AF27	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
AF28	PR85B	3	RLM0_GDLLC_FB_A	C	PR102B	3	RLM0_GDLLC_FB_A/RDQ99	C
GNDIO	GNDIO3	-			GNDIO3	-		
AD26	PR85A	3	RLM0_GDLLT_FB_A	T	PR102A	3	RLM0_GDLLT_FB_A/RDQ99	T
AJ32	PR84B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR101B	3	RLM0_GDLLC_IN_A**/ RDQ99	C (LVDS)*
AJ33	PR84A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR101A	3	RLM0_GDLLT_IN_A**/ RDQ99	T (LVDS)*
AJ34	PR83B	3	RLM0_GPLLC_IN_A**	C	PR100B	3	RLM0_GPLLC_IN_A**/ RDQ99	C
VCCIO	VCCIO3	3			VCCIO3	3		
AK34	PR83A	3	RLM0_GPLLT_IN_A**	T	PR100A	3	RLM0_GPLLT_IN_A**/ RDQ99	T
AH33	PR82B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR99B	3	RLM0_GPLLC_FB_A/RDQ99	C (LVDS)*
AH34	PR82A	3	RLM0_GPLLT_FB_A/RDQS82****	T (LVDS)*	PR99A	3	RLM0_GPLLT_FB_A/ RDQS99	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
AF29	PR81B	3	RDQ82	C	PR98B	3	RDQ99	C
AF31	PR81A	3	RDQ82	T	PR98A	3	RDQ99	T
AG33	PR80B	3	RDQ82	C (LVDS)*	PR97B	3	RDQ99	C (LVDS)*
AG34	PR80A	3	RDQ82	T (LVDS)*	PR97A	3	RDQ99	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
AF30	PR79B	3	RDQ82	C	PR96B	3	RDQ99	C
AF32	PR79A	3	RDQ82	T	PR96A	3	RDQ99	T
AE29	PR78B	3	RDQ82	C (LVDS)*	PR95B	3	RDQ99	C (LVDS)*
AE30	PR78A	3	RDQ82	T (LVDS)*	PR95A	3	RDQ99	T (LVDS)*
AF33	NC	-			PR93B	3	RDQ90	C
AF34	NC	-			PR93A	3	RDQ90	T
-	-	-			GNDIO3	-		
AC27	NC	-			PR92B	3	RDQ90	C (LVDS)*
AC28	NC	-			PR92A	3	RDQ90	T (LVDS)*
AD29	NC	-			PR91B	3	RDQ90	C
AD30	NC	-			PR91A	3	RDQ90	T
-	-	-			VCCIO3	3		
AE33	NC	-			PR90B	3	RDQ90	C (LVDS)*
AE34	NC	-			PR90A	3	RDQS90	T (LVDS)*
AD32	NC	-			PR89B	3	RDQ90	C
-	-	-			GNDIO3	-		
AD31	NC	-			PR89A	3	RDQ90	T
AB25	NC	-			PR88B	3	RDQ90	C (LVDS)*
AC25	NC	-			PR88A	3	RDQ90	T (LVDS)*
AB28	NC	-			PR87B	3	RDQ90	C
-	-	-			VCCIO3	3		
AA26	NC	-			PR87A	3	RDQ90	T
AD33	NC	-			PR86B	3	RDQ90	C (LVDS)*
AD34	NC	-			PR86A	3	RDQ90	T (LVDS)*
AC29	PR76B	3	RDQ73	C	PR84B	3	RDQ81	C
GNDIO	GNDIO3	-			GNDIO3	-		
AA27	PR76A	3	RDQ73	T	PR84A	3	RDQ81	T
AC32	PR75B	3	RDQ73	C (LVDS)*	PR83B	3	RDQ81	C (LVDS)*
AC31	PR75A	3	RDQ73	T (LVDS)*	PR83A	3	RDQ81	T (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
R21	VCC	-			VCC	-		
R22	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T21	VCC	-			VCC	-		
U14	VCC	-			VCC	-		
U21	VCC	-			VCC	-		
V14	VCC	-			VCC	-		
V21	VCC	-			VCC	-		
W14	VCC	-			VCC	-		
W21	VCC	-			VCC	-		
Y13	VCC	-			VCC	-		
Y14	VCC	-			VCC	-		
Y21	VCC	-			VCC	-		
Y22	VCC	-			VCC	-		
C12	VCCIO0	0			VCCIO0	0		
C16	VCCIO0	0			VCCIO0	0		
E14	VCCIO0	0			VCCIO0	0		
H12	VCCIO0	0			VCCIO0	0		
H16	VCCIO0	0			VCCIO0	0		
M14	VCCIO0	0			VCCIO0	0		
M15	VCCIO0	0			VCCIO0	0		
C19	VCCIO1	1			VCCIO1	1		
C23	VCCIO1	1			VCCIO1	1		
E21	VCCIO1	1			VCCIO1	1		
H19	VCCIO1	1			VCCIO1	1		
H23	VCCIO1	1			VCCIO1	1		
M20	VCCIO1	1			VCCIO1	1		
M21	VCCIO1	1			VCCIO1	1		
G32	VCCIO2	2			VCCIO2	2		
K28	VCCIO2	2			VCCIO2	2		
K32	VCCIO2	2			VCCIO2	2		
N27	VCCIO2	2			VCCIO2	2		
N32	VCCIO2	2			VCCIO2	2		
P23	VCCIO2	2			VCCIO2	2		
R23	VCCIO2	2			VCCIO2	2		
T27	VCCIO2	2			VCCIO2	2		
T32	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
AB27	VCCIO3	3			VCCIO3	3		
AB32	VCCIO3	3			VCCIO3	3		
AE28	VCCIO3	3			VCCIO3	3		
AE32	VCCIO3	3			VCCIO3	3		
AH32	VCCIO3	3			VCCIO3	3		
W27	VCCIO3	3			VCCIO3	3		
W32	VCCIO3	3			VCCIO3	3		
Y23	VCCIO3	3			VCCIO3	3		
AC20	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
AG19	VCCIO4	4			VCCIO4	4		

LatticeECP2M Standard Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2M20E-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2M20E-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2M20E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2M20E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2M20E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2M35E-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2M35E-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	COM	35
LFE2M35E-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2M35E-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2M35E-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2M35E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	35
LFE2M35E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	35
LFE2M35E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	COM	50
LFE2M50E-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	COM	50
LFE2M50E-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	COM	50
LFE2M50E-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2M50E-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2M50E-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	COM	50
LFE2M50E-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2M50E-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2M50E-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	COM	70
LFE2M70E-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	COM	70
LFE2M70E-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	COM	70
LFE2M70E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2M70E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2M70E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	70